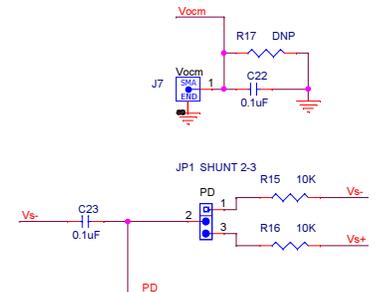
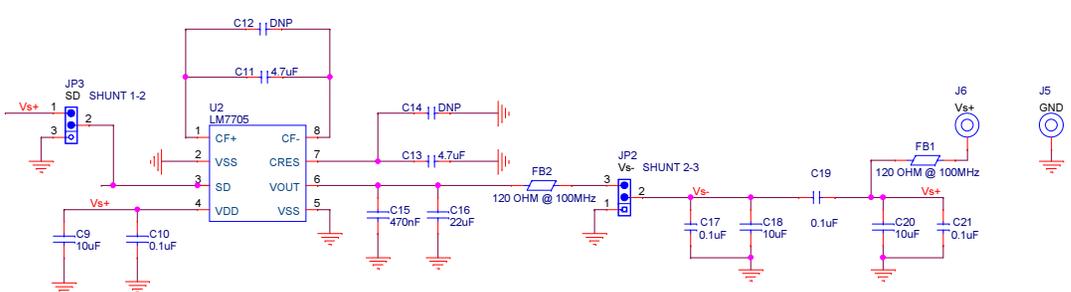
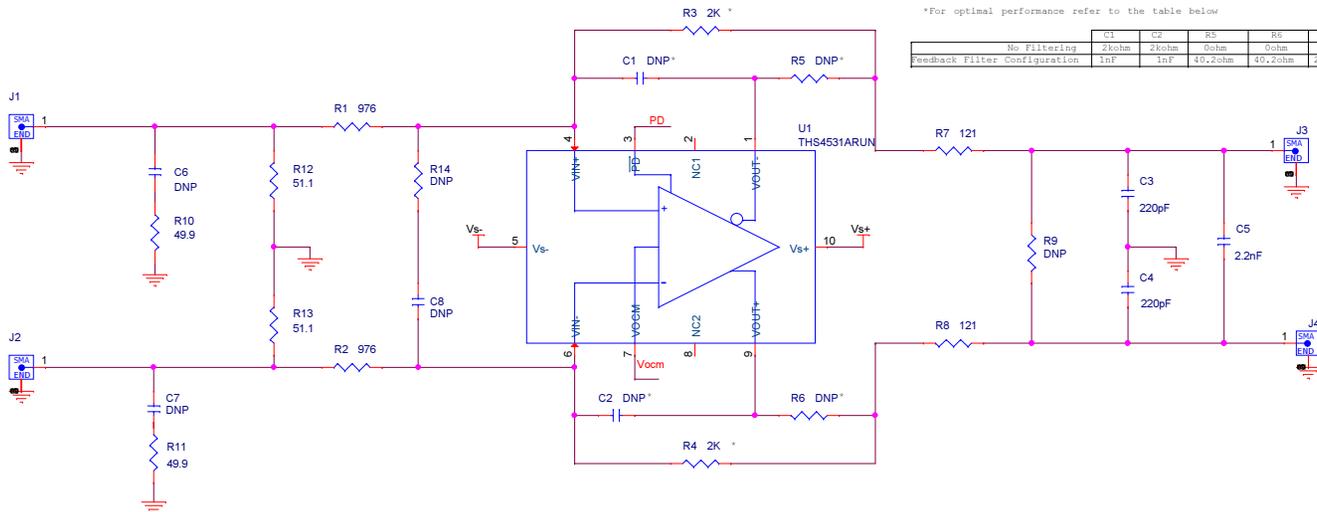
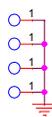


*For optimal performance refer to the table below

	C1	C2	R5	R6	R3	R4
No Filtering	2kohm	2kohm	0ohm	0ohm	DNP	DNP
Feedback Filter Configuration	1nF	1nF	40.2ohm	40.2ohm	2kohm	2kohm



- Z_STANDOFF SCREW1
PANHEAD SCREW 4-40 x 3/8
Z_STANDOFF1
 - Z_STANDOFF SCREW2
PANHEAD SCREW 4-40 x 3/8
Z_STANDOFF2
 - Z_STANDOFF SCREW3
PANHEAD SCREW 4-40 x 3/8
Z_STANDOFF3
 - Z_STANDOFF SCREW4
PANHEAD SCREW 4-40 x 3/8
Z_STANDOFF4
- STANDOFF ALUM HEX 4-40 x .75 STANDOFF ALUM HEX 4-40 x .75 STANDOFF ALUM HEX 4-40 x .75 STANDOFF ALUM HEX 4-40 x .75



Title		
THS4531ARUN Extended Range		
Engineer: L. Lapointe	Size B	Document Number
Drawn By: L. Lapointe	CIRCUIT TYPE	
FILE:	Date: Thursday, February 27, 2014	Sheet 1 of 1
		Rev A

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